

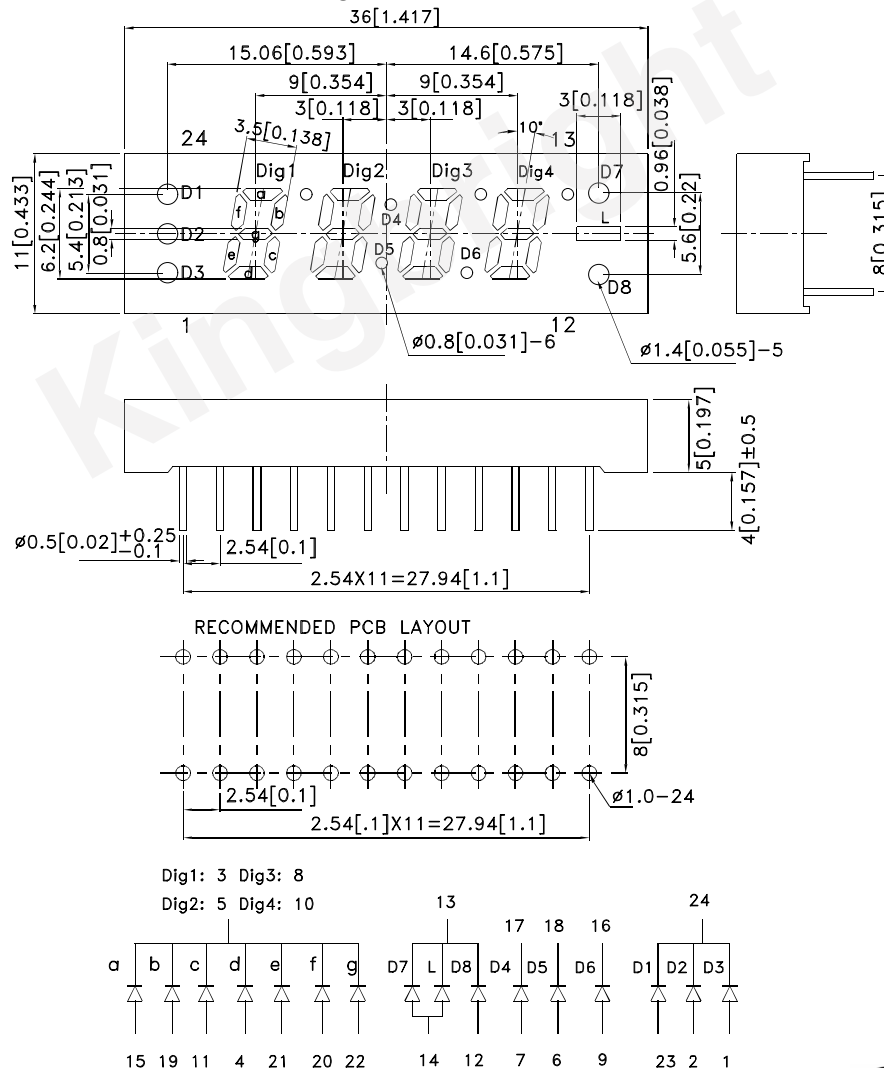
Features

- 0.25 inch digit height
- Low current operation.
- Excellent character appearance.
- Easy mounting on P.C. boards or sockets.
- Categorized for luminous intensity.
- Mechanically rugged.
- Standard : gray face, white segment.
- RoHS compliant.

Description

The Hyper Red source color devices are made with Al-GaN/P on GaAs substrate Light Emitting Diode.

Package Dimensions& Internal Circuit Diagram



Notes:

1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.



Selection Guide

Part No.	Dice	Lens Type	Iv (ucd) [1] @ 10mA		Description
			Min.	Typ.	
CC25-12SURKWA	Hyper Red (AlGaInP)	White Diffused	31000	80000	Common Cathode
			*14000	*24000	

Notes:

1. Luminous intensity/ luminous Flux: +/-15%.

* Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter		Device	Typ.	Max.	Units	Test Conditions
λ peak	Peak Wavelength		Hyper Red	645		nm	I _F =20mA
λ D [1]	Dominant Wavelength		Hyper Red	630		nm	I _F =20mA
$\Delta\lambda$ 1/2	Spectral Line Half-width		Hyper Red	28		nm	I _F =20mA
C	Capacitance		Hyper Red	35		pF	V _F =0V;f=1MHz
V _F [2]	Forward Voltage	Dig1'8,'Dig2'8',Dig3'8',Dig4'8' D1,D2,D3,D4,D5,D6,D8	Hyper Red	1.95	2.5	V	I _F =20mA
		D7,L					
I _R	Reverse Current	Dig1'8,'Dig2'8',Dig3'8',Dig4'8' D1,D2,D3,D4,D5,D6,D8	Hyper Red		10	uA	V _R = 5V
		D7,L			20		

Notes:

1.Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

* Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter		Hyper Red	Units
Power dissipation	Dig1'8,'Dig2'8',Dig3'8',Dig4'8' D1,D2,D3,D4,D5,D6,D8	75	mW
	D7,L	150	
DC Forward Current	Dig1'8,'Dig2'8',Dig3'8',Dig4'8' D1,D2,D3,D4,D5,D6,D8	30	mA
	D7,L	60	
Reverse Voltage	Dig1'8,'Dig2'8',Dig3'8',Dig4'8' D1,D2,D3,D4,D5,D6,D8	5	V
	D7,L		
Peak Forward Current [1]	Dig1'8,'Dig2'8',Dig3'8',Dig4'8' D1,D2,D3,D4,D5,D6,D8	185	mA
	D7,L	370	
Operating/Storage Temperature		-40°C To +85°C	
Lead Solder Temperature [2]		260°C For 3~5 Seconds	

Notes:

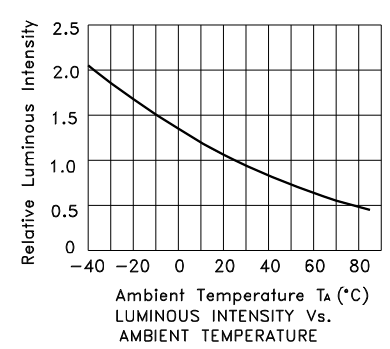
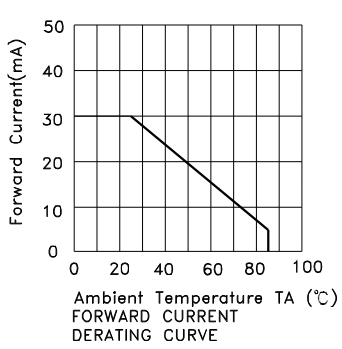
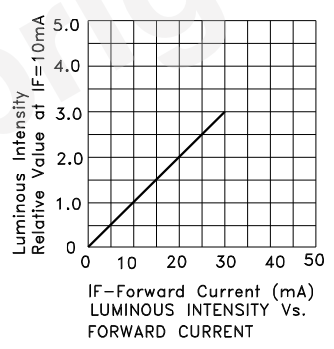
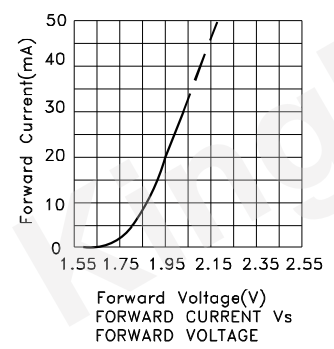
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

2. 2mm below package base.

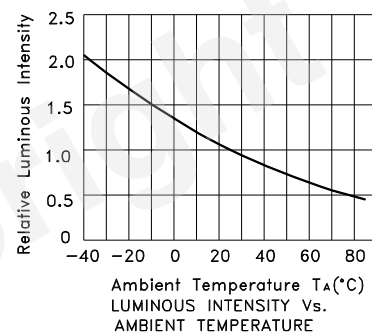
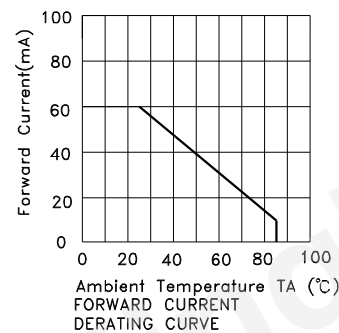
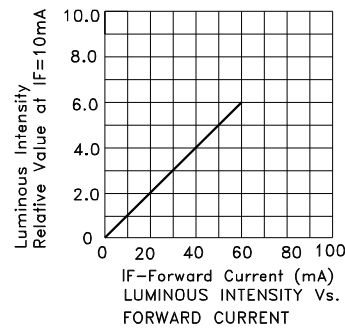
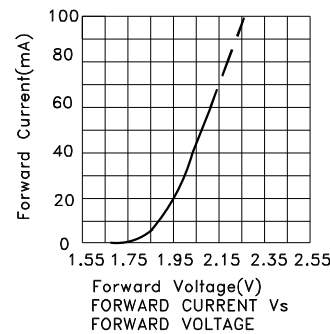


Hyper Red

CC25-12SURKWA

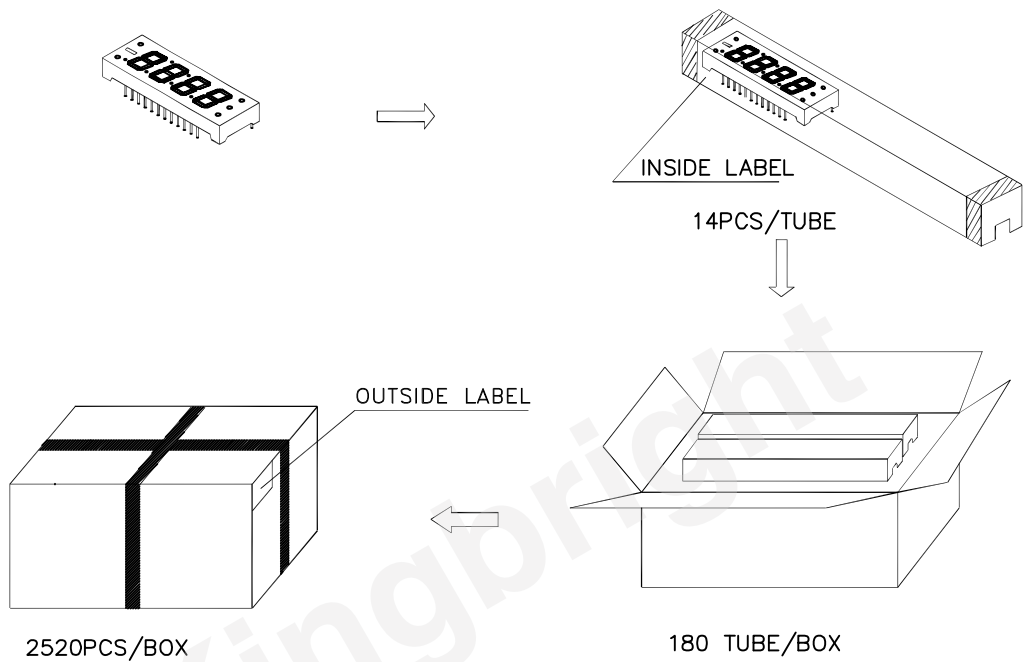


Hyper Red



PACKING & LABEL SPECIFICATIONS

CC25-12SURKWA



Inside Label on Ic-Tube

Kingbright	TYPE: CX25-12XXX	CODE: xx	PASSED xx xx xx FQCX	Date
QTY: 14PCS	RoHS Compliant			Number OF FQC
XXXXXXXXXX-XXXX	LOT NO.			

Outside Label on Box

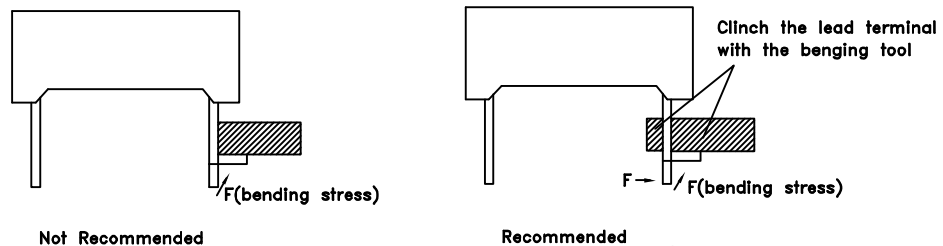
XXXXXX	Bin Code			Number OF QA
CX25-12XXX	XX	QAx xx xx xx PASSED	Date	
2520 PCS	RoHS Compliant			

THROUGH HOLE DISPLAY MOUNTING METHOD

Lead Forming

Do not bend the component leads by hand without proper tools.

The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.

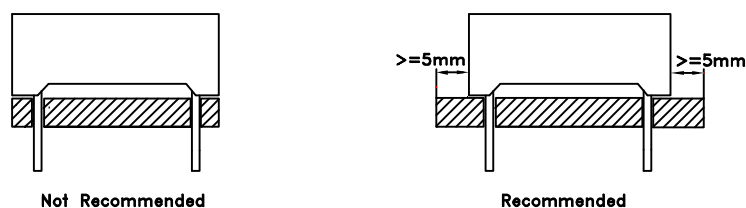


Installation

- 1.The installation process should not apply stress to the lead terminals.
- 2.When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.

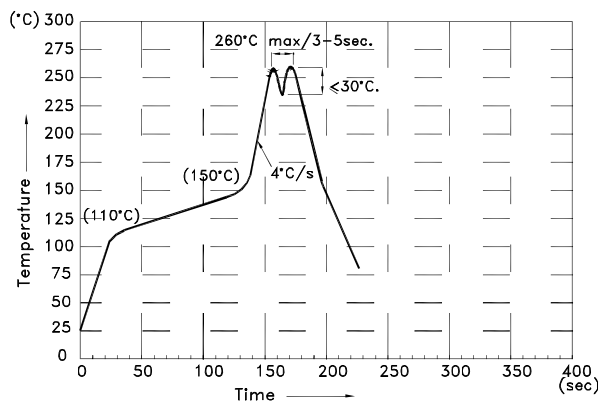


- 3.The component shall be placed at least 5mm from edge of PCB to avoid damage caused excessive heat during wave soldering.



DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

1. Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
2. Do not apply stress on epoxy resins when temperature is over 85°C.
3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
4. During wave soldering, the PCB top-surface temperature should be kept below 105°C.
5. No more than once.

Soldering General Notes:

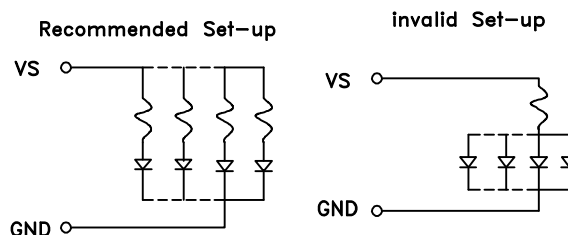
1. Through-hole displays are incompatible with reflow soldering.
2. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING

1. Mild "no-clean" fluxes are recommended for use in soldering.
2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts. And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES

1. Protective current-limiting resistors may be necessary to operate the Displays.
2. LEDs mounted in parallel should each be placed in series with its own current-limiting resistor.



Detailed application notes are listed on our website.

http://www.kingbright.com/application_notes